



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of	:	Confirmation No. 5528
Etsuko NAKAMURA et al.	:	Attorney Docket No. 2003_1698A
Serial No. 10/721,164	:	Group Art Unit 1752
Filed November 26, 2003	:	Examiner Amanda C. Walke
LOWER LAYER MATERIAL FOR WIRING, EMBEDDED MATERIAL, AND WIRING FORMATION METHOD		Mail Stop: RCE

SUBMISSION UNDER 37 C.F.R. 1.114

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Final Rejection dated February 24, 2006, please amend the present application as follows: